

Power line chokes

Current-compensated D core double chokes 250 V AC, 3.3 ... 68 mH, 0.7 ... 4.6 A, +40 °C / +60 °C

Series/Type: B82734R/W

Date: February 2025

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Current-compensated D core double chokes

Rated voltage 250 V AC Rated current 0.7 ... 4.6 A / +40 °C, +60 °C Nominal inductance 3.3 ... 68 mH

Construction

- Current-compensated double choke
- Closed rectangular ferrite core
- Closed plastic coil former (UL 94 V-0)¹)
- Without encapsulation
- 2-section winding
- Clearance and creepage distances ≥ 3 mm

Features

- High resonance frequency due to 2-section winding
- Approx. 0.55% stray inductance for symmetrical interference suppression
- Low leakage due to closed core shape
- High pulse strength
- Low whirring noise
- Suitable for wave soldering
- Design complies with EN 60938-2 (VDE 0565-2) and UL 1283
- UL²⁾ and ENEC (VDE) approvals **N (**
- Recyclable owing to omission of encapsulation and glue
- RoHS-compatible

Applications

- Suppression of common-mode interferences
- Switch-mode power applications
- Electronic ballasts in lamps

Terminals

- Base material CuNi18Zn20
- Layer composition Ni, Sn
- Hot-dipped
- Pins 0.7 × 0.7 (mm)
- Lead spacing 15 × 12.5 (mm)

Marking

Product brand, nominal inductance, rated current, ordering code, approval signs, date of manufacture (YYWW)

Delivery mode

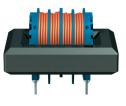
Blister tray in cardboard box

- 1) Additionally certified values:
 - Glow wire flammability index (GWFI to IEC 60695-2-12): +850 °C +775 °C
 - Glow wire ignition temperature (GWIT to IEC 60695-2-13):
 - Glow wire test (GWT to IEC 60695-2-11): +750 °C, 2 s / 850 °C, 30 s 175 V
 - Comparative tracking index (CTI to IEC 60112): Ball pressure test (BP to IEC 60695-10-2):
- +125 °C

- 2) UL approval with 300 V AC.



B82734R



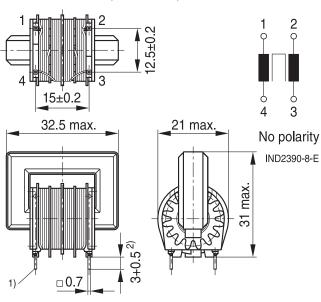
B82734W



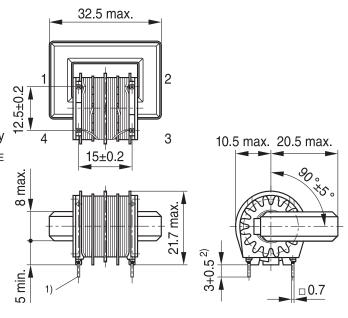
Current-compensated D core double chokes

Dimensional drawings and pin configurations





Horizontal version (B82734W)



IND2419-F-E

Part tolerances to ISO 2768-c / ISO 8015.

Size ISO 14405 (E)

IND2439-T-E

All dimensions in mm



IND2140-B-E

¹⁾ Tin tips permissible

²⁾ Dimension does not include tin tip

¹⁾ Tin tips permissible2) Dimension does not include tin tip



Current-compensated D core double chokes

Technical data and measuring conditions

Rated voltage V _R	250 V AC (50/60 Hz)			
Test voltage V _{test}	1500 V AC, 2 s (line/line)			
Rated temperature T _R	+40 °C / +60 °C			
Rated current I _R	Referred to 50 Hz and rated temperature			
Nominal inductance L _N	Measured with Agilent 4284A at 10 kHz, 0.1 mA, +20 °C Inductance is specified per winding.			
Inductance tolerance	-30%/+50% at +20°C			
Inductance decrease ΔL/L ₀	< 10% at DC magnetic bias with I _R , +20 °C			
Stray inductance L _{stray,typ}	Measured with Agilent 4284A at 10 kHz, 5 mA, +20 °C, typ. values			
DC resistance R _{typ}	Measured at +20 °C, typical values, specified per winding			
Solderability (lead-free)	Sn96.5Ag3.0Cu0.5: +(245 \pm 3) °C, (3 \pm 0.3) s Wetting of soldering area \geq 95% (to IEC 60068-2-20, test Ta)			
Resistance to soldering heat (wave soldering)	+(260 ±5) °C, (10 ±1) s (to IEC 60068-2-20, test Tb)			
Climatic category	40/125/56 (to IEC 60068-1)			
Storage conditions (packaged)	–25 °C +40 °C, ≤ 75% RH			
Weight	Approx. 30 g			
Approvals	IEC / EN 60938-2, UL 1283 (E70122)			

Characteristics and ordering codes

I _R	L _N	L _{stray,typ}	R _{typ}	T _R	Ordering code		Approvals	
Α	mH	μΗ	mΩ	°C	Vertical version	Horizontal version	10 <u>6°</u> 2	<i>9</i> 1
0.7	68	410	1450	+60	B82734R2701B030	B82734W2701B030	×	×
1.3	47	250	560	+40	B82734R2132B030	B82734W2132B030	×	×
1.4	39	210	460	+40	B82734R2142B030	B82734W2142B030	×	×
1.7	27	140	320	+40	B82734R2172B030	B82734W2172B030	×	×
2.0	20	105	240	+40	B82734R2202B030	B82734W2202B030	×	×
2.3	15	80	185	+40	B82734R2232B030	B82734W2232B030	×	×
2.6	10	53	130	+40	B82734R2262B030	B82734W2262B030	×	×
3.2	6.8	35	85	+40	B82734R2322B030	B82734W2322B030	×	×
4.6	3.3	17	46	+40	B82734R2462B030	B82734W2462B030	×	×

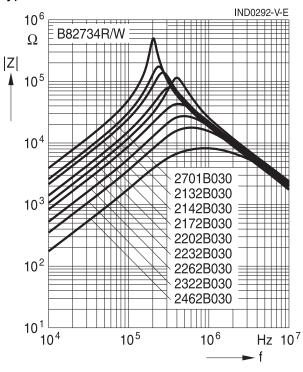
 $[\]times$ = approval granted



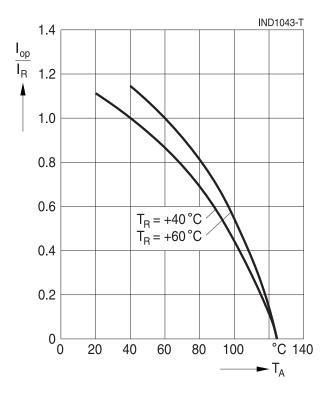
Current-compensated D core double chokes

Impedance |Z| versus frequency f

measured with windings in parallel at +20 °C typical values



Current derating I_{op}/I_R versus ambient temperature TA





Cautions and warnings

- Please note the recommendations in our Inductors data book (latest edition), online catalogs and in the data sheets.
 - Particular attention should be paid to the derating curves, if given. Derating applies in the case the ambient temperature in application exceeds the rated temperature of the component.
 - Ensure the operation temperature of the component in application not to exceed the maximum specified value or the upper climatic category temperature.
 - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pins only. Temperatures specified in relation to reflow soldering can also refer to the pins or terminals for products with larger thermal mass, as in such cases, the temperature difference to the top of the component is too big (e.g., high proportion of core within the component).
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. It is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
 - Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g., ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.
- The following points must be observed if the components are potted, sealed, or varnished in customer applications:
 - Many potting, sealing, or varnishing materials shrink as they harden. They therefore exert a
 pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
 - It is necessary to check whether the potting, sealing or varnishing materials used attack or destroy the wire insulation, plastics, or glue.
 - The effect of the potting, sealing, or varnishing materials may change the high-frequency behavior of the components.
- Magnetic core materials such as ferrites are sensitive to direct impact. This can cause the core material to flake or lead to breakage of the magnetic core material.
- Any type of tension or pressure on the product may result in damage and affect its functionality and reliability.
 - The products are only to be attached to fixings or mounting holes provided for this purpose in accordance with the data sheet.
 - If additional mechanical forces are applied to the component, e.g., application of gap pads, it
 is necessary to check whether they attack or destroy any part of the component.
 - It is not permitted for the product specified in the data sheet to assume a mechanical function in the final application.
- Inductance value can drop if external metallic or magnetic parts will be put close to the coil or into the air gap of the coil or core or magnetic material.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.

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Cautions and warnings

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- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
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- Unless otherwise agreed in individual contracts, all orders are subject to our General Terms and Conditions of Supply.

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Important notes

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